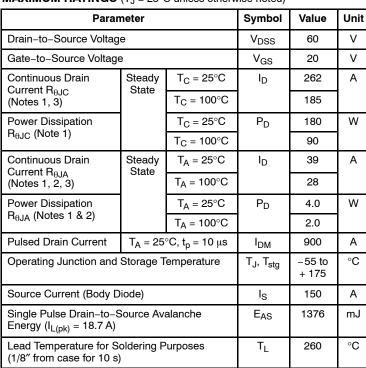
<u>MOSFET</u> – Power, Single N-Channel

60 V, 1.3 mΩ, 262 A

NVMJS1D4N06CL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- LFPAK8 Package, Industry Standard
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant



MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	0.83	°C/W
Junction-to-Ambient - Steady State (Note 2)	Веца	37.8	

 The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

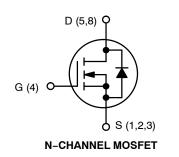
3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

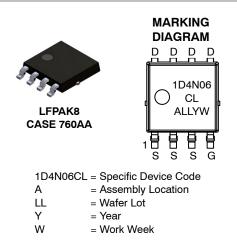


ON Semiconductor®

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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
60 V	1.3 mΩ @ 10 V	262 A
00 V	1.8 mΩ @ 4.5 V	202 7





ORDERING INFORMATION

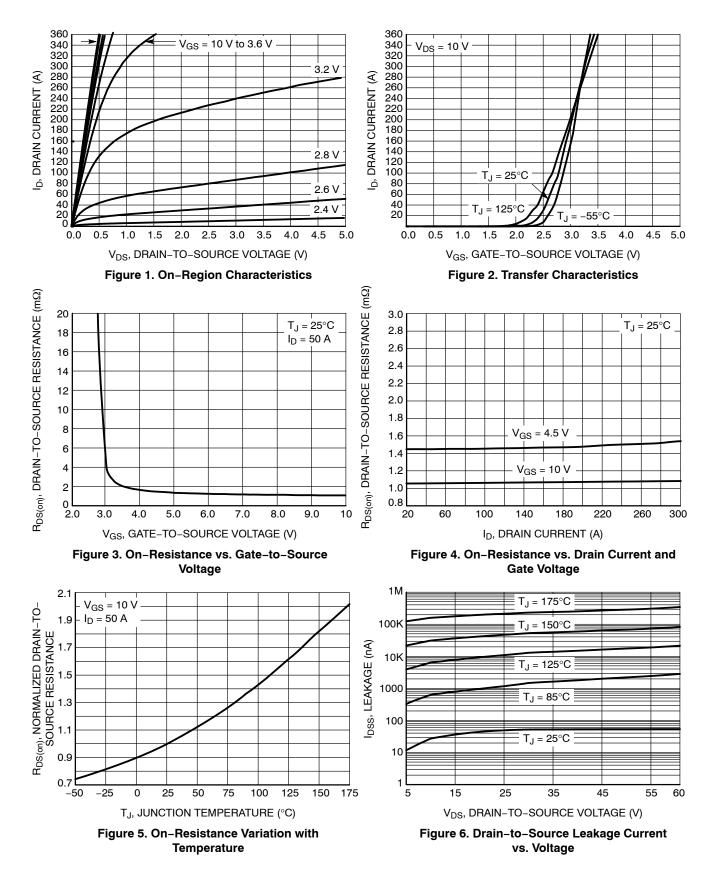
See detailed ordering, marking and shipping information on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

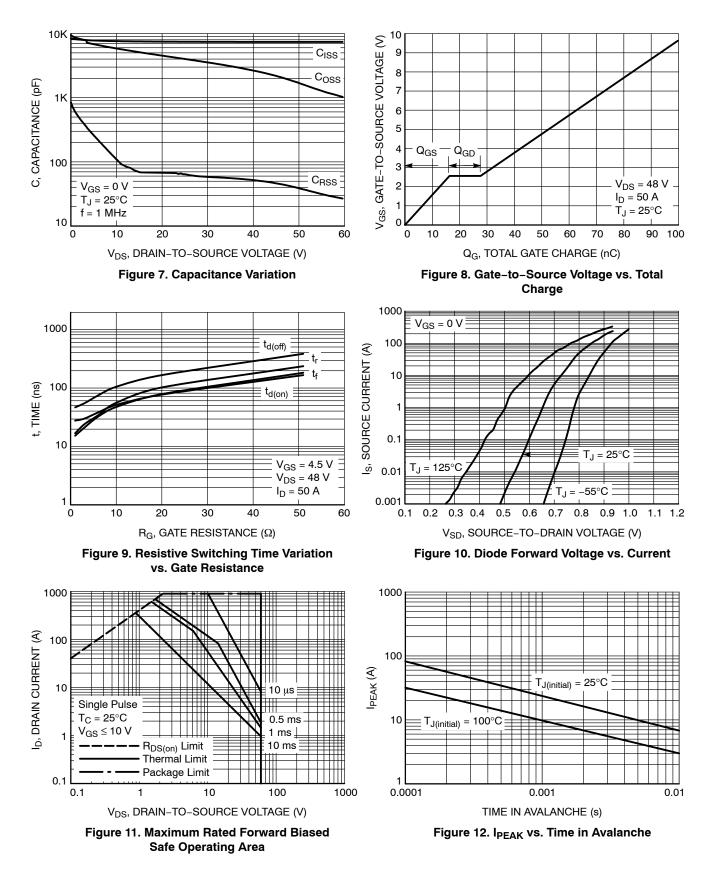
Parameter	Symbol	Test Cond	lition	Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				25		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	T _J = 25 °C			10	μA
		V _{DS} = 60 V	T _J = 125°C			250	1
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = 20 V				100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = 280 \ \mu A$		1.2		2.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				5.3		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 4.5 V	I _D = 50 A		1.45	1.8	mΩ
		V _{GS} = 10 V	I _D = 50 A		1.07	1.3	1
Forward Transconductance	9 _{FS}	V _{DS} =15 V, I _D = 50 A			244		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE				•		
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 30 V			7430		pF
Output Capacitance	C _{OSS}				3500		
Reverse Transfer Capacitance	C _{RSS}				57		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 4.5 V, V_{DS} = 48 V; I_{D} = 50 A			47		nC
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 48 V; I_{D} = 50 A			103		1
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _{DS} = 48 V; I _D = 50 A			10		
Gate-to-Source Charge	Q _{GS}				17		
Gate-to-Drain Charge	Q _{GD}				11		
Plateau Voltage	V _{GP}				2.6		V
SWITCHING CHARACTERISTICS (Note 5	5)			-		-	-
Turn-On Delay Time	t _{d(ON)}	V _{GS} = 4.5 V, V	_{DS} = 48 V,		29		ns
Rise Time	tr	V_{GS} = 4.5 V, V_{DS} = 48 V, I_{D} = 50 A, R_{G} = 2.5 Ω			21		
Turn-Off Delay Time	t _{d(OFF)}				52		
Fall Time	t _f				19		
DRAIN-SOURCE DIODE CHARACTERIS	TICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 50 A	$T_J = 25^{\circ}C$		0.78	1.2	V
			T _J = 125°C		0.66		1
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 \text{ V, } dI_{s}/dt = 100 \text{ A}/\mu s,$ $I_{S} = 50 \text{ A}$			86		ns
Charge Time	t _a				58		
Discharge Time	t _b				28		
Reverse Recovery Charge	Q _{RR}			l	175		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width \leq 300 µs, duty cycle \leq 2%. 5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

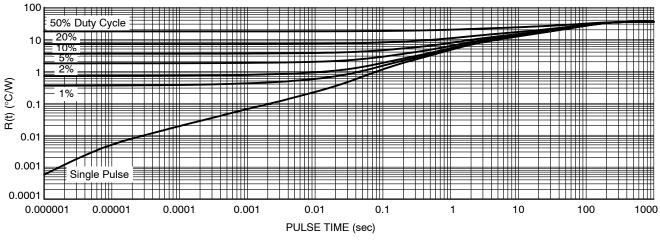


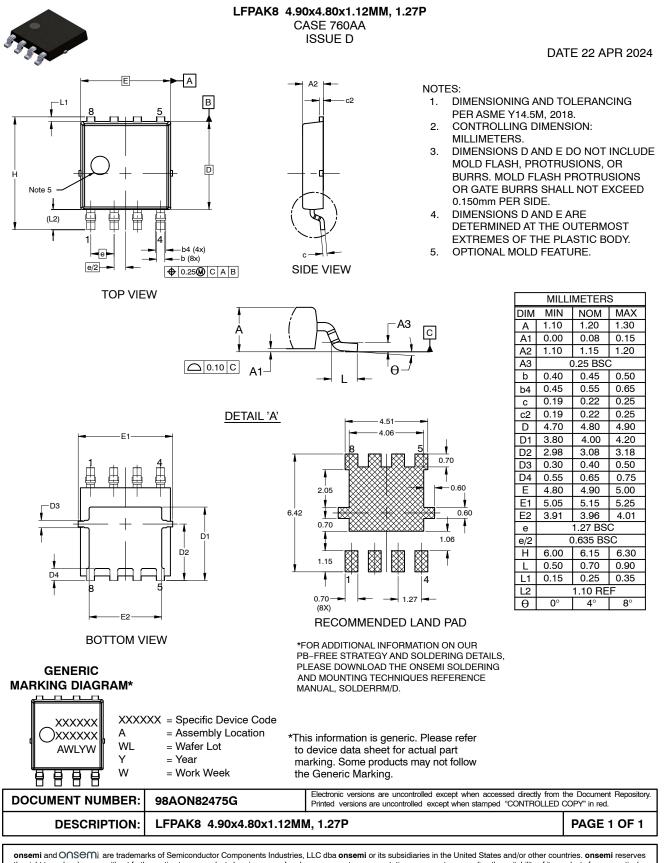
Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMJS1D4N06CLTWG	1D4N06CL	LFPAK8 (Pb–Free)	3000 / Tape & Reel

⁺For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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